16 Channel Output LED Driver with 14 bit PWM Controller

LD1071

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Ver. 1.0 / Mar. 2009

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LD1071 Revision History

Version	Contents	Transfer Date
1.0	- First Version	2009.03.12



DESCRIPTION

The LD1071 is specifically designed for LED and LED display applications using PWM(Pulse Width Modulation) control with 14 bit color depth. The LD1071 provides a constant output current for driving the LEDs against for the variation of LED forward voltage(Vf). The constant output current can be preset through an external resistor. Moreover, the preset output current with external resistor can be programmed up to 256 levels for LED global brightness adjustment. The LD1071 consists of 16 bit shift registers, latches, and-gates, constant current driver and 14 bit PWM controller.

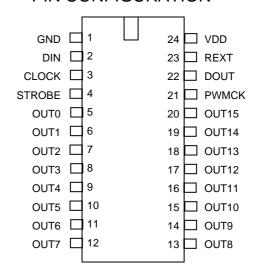
FEATURES

Output current: set-up at 5mA to 45mA with an external resistor

(when VDD=3.3V, lout: $5mA \sim 30mA$)

- · Include error detection circuit
- 16 constant current output channels
- 14 bit gray scale PWM control
- · 8 bit programmable output current control
- · Constant current accuracy
 - Pin to pin deviation : < ±3% (Max)
 - Chip to chip deviation : < ±6% (Max)
- 3.3V / 5V CMOS compatible input
- Package : LD1071-SP (SOP-24), LD1071-SS (SSOP-24)
- Maximum CLOCK input frequency : 25MHz
- Maximum PWMCK input frequency: 25MHz

PIN CONFIGURATION

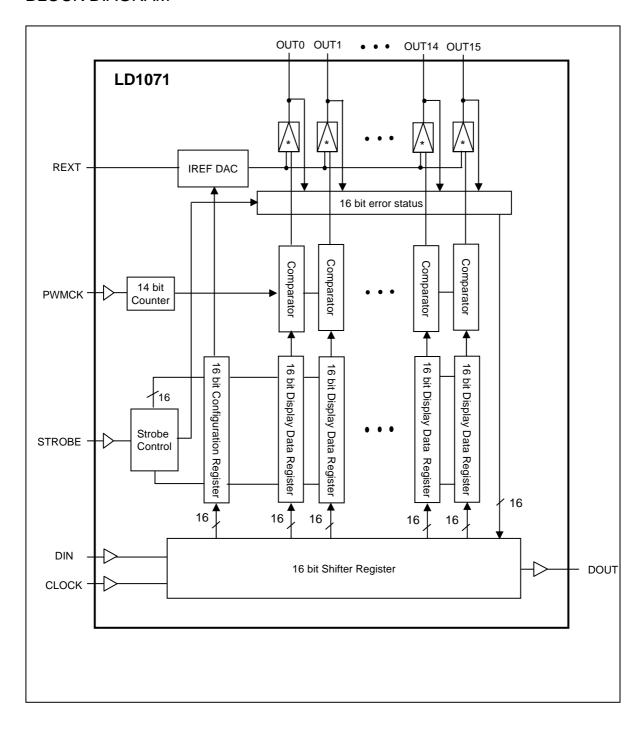


PIN DESCRIPTION

PIN NO.	PIN NAME	DESCRIPTION
1	GND	Ground signal
2	DIN	Serial input data
3	CLOCK	Shift input clock for serial input data DIN(Rising Edge Clocking)
4	STROBE	Data strobe signal. This pin is a pull-down type.
5~12 13~20	OUTn	Constant current outputs, n = 0 ~ 15
21	PWMCK	PWM gray scale clock signal. This pin is a pull-up type.
22	DOUT	Serial data output
23	REXT	Connect the resistor between this pin and GND to set up the constant output current for all the OUTn.
24	VDD	Power supply signal (3.3V/5V)



BLOCK DIAGRAM





ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS

 $(Ta = 25^{\circ}C)$

PARAMETER		SYMBOL	RATING	UNIT
Supply Voltage		V _{DD}	0~7.0	V
Output Voltage		V _{OUT}	-0.5~13.5	V
Output Current		Іоит	450	mA
Input Voltage		V _{IN}	-0.4~V _{DD} +0.4	V
GND Terminal Curre	GND Terminal Current		960	mA
CLOCK Frequency		fск	25	MHz
PWMCK Frequency		f _{PWMCK}	25	MHz
Danie Bianie dian	SOP	_	1.67	
Power Dissipation	SSOP	P _D	1.48	W
Thermal Resistance	SOP	Dah/i a)	75	0.47
(On PCB, TA = 25) SSOP		Rth(j-a)	85	/W
Operating Temperature		T _{opr}	-40~85	°C
Storage Temperature)	T _{stg}	-55~150	°C



RECOMMENDED OPERATING CONDITIONS

DC CHAR	DC CHARACTERISTICS			TYP.	MAX.	UNIT
Supply Voltage	V _{DD}	4.5	5	5.5	٧	
LED Driver Output Voltag	е	V _{out}			13.5	٧
Input	"H" Level	V _{IH}	0.8V _{DD}	-	V _{DD}	V
Voltage	"L" Level	V _{IL}	GND	-	0.2V _{DD}	v
Output	DOUT	V _{OL}	-	-	0.2V _{DD}	v
Voltage	DOUT	V _{OH}	0.8V _{DD}	-	-	v
High Level Output Currer	t	I _{OH}			-1	mA
Low Level Output Curren	t	I _{OL}			1	mA
LED Driver Output Curre	nt	I _{out}			20	mA
Operating Free-air Tempe	erature Range		-40		85	°C
AC CHAR	ACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT
CLOCK Frequency		f _{CK}			25	MHz
DWMCK Fraguency	@5V	f _{PWMCK}			25	MHz
PWMCK Frequency	@3.3V	f _{PWMCK}			20	MHz
	CLOCK	t _{WH0} / t _{WL0}	20			ns
Pulse Width	PWMCK	t _{wH1}	40			ns
	STROBE	t _{WH2}	40			ns
Setup Time	t _{setup}	15			ns	
Hold Time		t _{hold}	15			ns

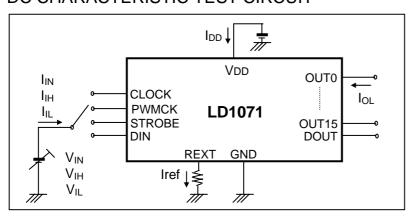


ELECTRICAL CHARACTERISTICS (VDD = 5V, Ta = 25°C)

Parameter		Symbol	Test Condition	Min.	Тур.	Max.	Unit
Input	Input H Level		-	0.7VDD		VDD	V
Voltage	L Level	VIL	-	GND		0.3VDD	V
Output Leak	kage Current	IOZ	VOH=6.0V			1	uA
Output	DOUT	VOL	IOL=1mA			0.2VDD	V
Voltage	DOOT	VOH	IOH=1mA	0.8VDD			V
•	Output Current1 Pin to Pin Deviation		REXT=500 IOUT=40mA, VOUT=1.5V		±1.5	±3.0	%
1	Output Current1 Chip to Chip Deviation		REXT=500 IOUT=40mA, VOUT=1.5V		±3.0	±6.0	%
1	Output Current vs. Supply Voltage Regulation		REXT=500 IOUT=40mA, VOUT=1.5V		±0.5	±1.0	%/V
Pull Up	Resistor	RINUP	-	100	200	400	1.0
Pull Down Resistor		Pull Down Resistor RINDN		100	200	400	kΩ
Supply Current		IOFF1	REXT=Open, OUTn=OFF REF=FFh, PWM=Gray0	-	0.4	0.8	
Supply	Current	IOFF2	REXT=500 , OUTn=OFF REF=FFh, PWM=Gray0	-	4.5	7.0	mA

(Note) REF: Constant Current Control Value (CR[7:0] of Configuration Register)

DC CHARACTERISTIC TEST CIRCUIT





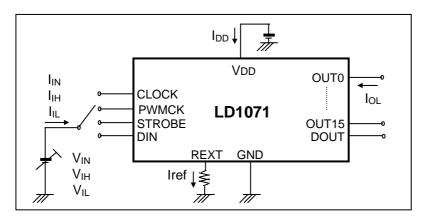
ELECTRICAL CHARACTERISTICS

(VDD = 3.3V, Ta = 25°C)

Parameter		Symbol	Test Condition	Min.	Тур.	Max.	Unit	
Input			-	0.7VDD		VDD	V	
Voltage	L Level	VIL	-	GND		0.3VDD		
Output Leak	kage Current	IOZ	VOH=6.0V			1	uA	
Output		VOL	IOL=1mA			0.2VDD		
Voltage	DOUT	VOH	IOH=1mA	0.8VDD			V	
	Current1 Deviation	IOLPP1	REXT=500 IOUT=36mA, VOUT=1.5V		±1.5	±3.0	%	
	Output Current1 Chip to Chip Deviation		REXT=500 IOUT=36mA, VOUT=1.5V		±3.0	±6.0	%	
1	current vs. ge Regulation	%/VDD	REXT=500 IOUT=36mA, VOUT=1.5V		±0.5	±1.0	%/V	
Pull Up	Resistor	RINUP	-	150	300	500	10	
Pull Dow	Pull Down Resistor		-	150	300	500	kΩ	
Supply Current		IOFF1	REXT=Open, OUTn=OFF REF=FFh, PWM=Gray0	-	0.4	0.6	mA	
Зирріу	Current	IOFF2	REXT=500 , OUTn=OFF REF=FFh, PWM=Gray0	-	4.5	7.0	IIIA	

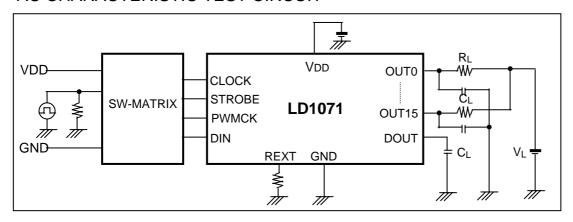
(Note) REF : Constant Current Control Value (CR[7:0] of Configuration Register)

DC CHARACTERISTIC TEST CIRCUIT





AC CHARACTERISTIC TEST CIRCUIT



SWITCHING CHARACTERISTICS

(Ta = 25°C unless otherwise noted)

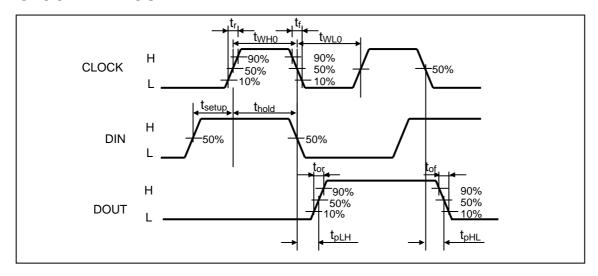
PARAMETER		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Propagation	CLOCK-DOUT			-	10	20		
Delay Time ("L" to "H")	PWMCK-OUTn	t _{pLH}		-	-	50	ns	
Propagation	CLOCK-DOUT			-	10	20		
Delay Time ("H" to "L")	PWMCK-OUTn	t _{pHL}		-	-	30	ns	
Maximum CLO	CK Frequency	f _{CKMAX} (*1)		•	10	25	MHz	
Maximum PWM	ICK Frequency	f _{PWMCKMAX} (*1)		-	8	25	MHz	
	СГОСК	t _{WH0} / t _{WL0}	t _{WH0} / t _{WL0} t _{WH1} V _{DD} = 5.0V		20	-	ns	
Pulse Width	PWMCK	t _{WH1}			20	-	ns	
	STROBE t _{w/10} V _{IH} = VDD			15	20	-	ns	
Data Set Up Tin	Data Set Up Time		f _{CK} = 10MHz R _{EXT} = 1590	10	15	-		
Data Hold Time		t _{hold (D)}	I _{OUT} = 19.1mA C _L = 10.0pF R _L = 150 VL = 4.5V	10	15	-	ns	
STROBE	LH			10	15	-		
Set Up Time	HL	t _{STB} setup		10	15	-	ns	
STROBE	LH	4 1.11		10	-	-		
Hold Time	HL	t _{STB} hold		10	-	-	ns	
Maximum Clock Rise Time		t _r		-	-	30		
Maximum Clock Fall Time		t _f		-	-	30	ns	
Output Rise Tir	Output Rise Time (OUTn)			-	-	30		
Output Fall Tim	ne (OUTn)	t _{of}		-	-	30	ns	
Global Latch So	et Up Time	tglc		20	-	-	ns	

^{*1 :} Cascade Operation

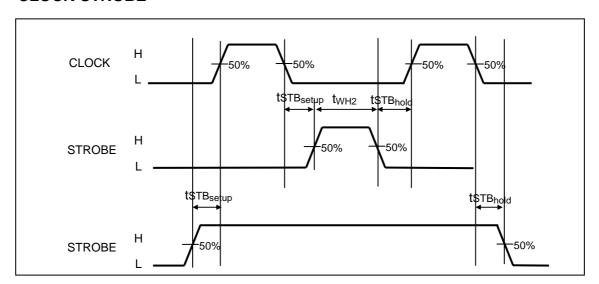


TIMING WAVEFORM

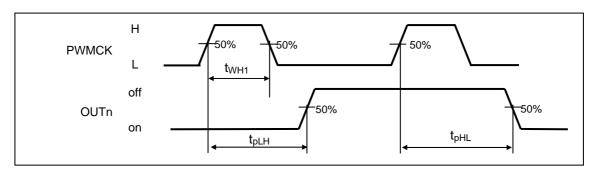
CLOCK-DIN-DOUT



CLOCK-STROBE

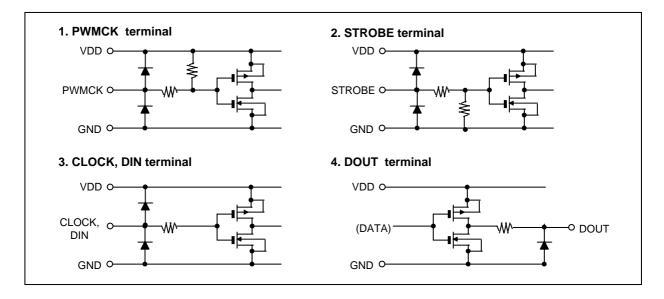


PWMCK-OUTn





EQUIVALENT CIRCUIT OF INPUTS AND OUTPUTS





FUNCTIONAL DESCRIPTION

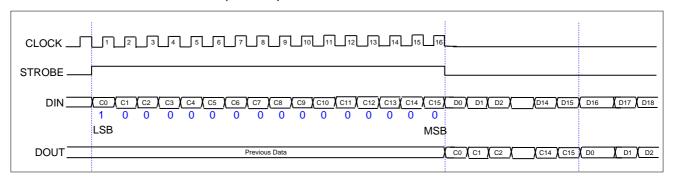
COMMAND TABLE

Command Name	Command Value	Description
Software Reset Command	0001h	This command should be issued after power supply input. The Configuration Register, internal shift register, Display Data Register will be cleared with '0' states.
Configuration Register Write Command	0034h	This command is used to update the contents of Configuration Register.
Configuration Register Read Command	0038h	This command is used to read the status of Configuration Register.
Error Status Read Command	003Ch	This command is used to check the 'Open/Short' error status of LED.
Display Data Write Command	0084h	This command is used to write the display image data into LED driver IC for display system.
Global Latch Command	-	This command is used to deliver the internal display data register outputs latched by Display Data Write Command to the internal PWM comparator to make an output current. The Global Latch Command should be transferred after sending the final display data you want. The Global Latch Command has no command value but it needs a special execution sequence.

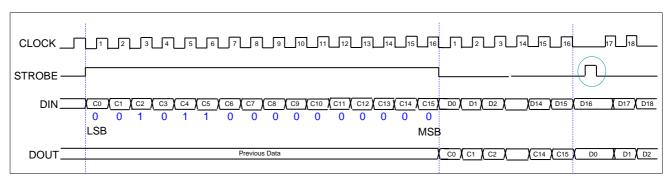


TIMING DIAGRAM OF COMMAND CONTROL

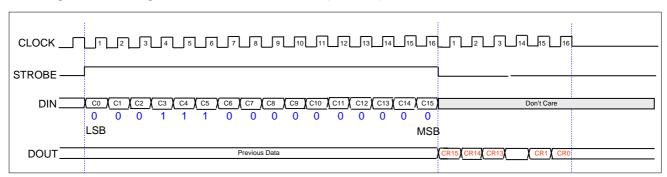
Software Reset Command (0001h)



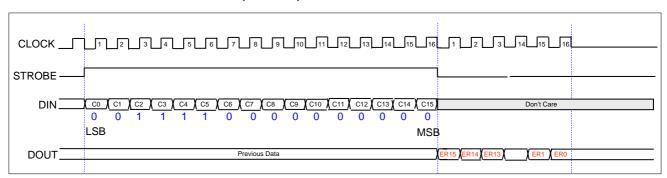
Configuration Register Write Command (0034h)



Configuration Register Read Command (0038h)



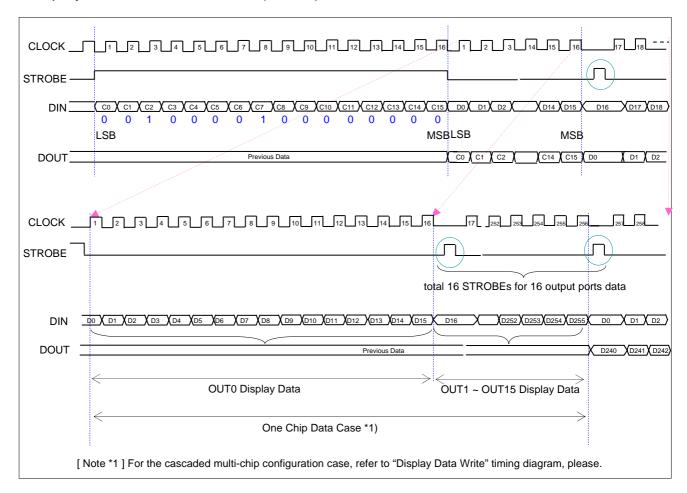
Error Status Read Command (003Ch)



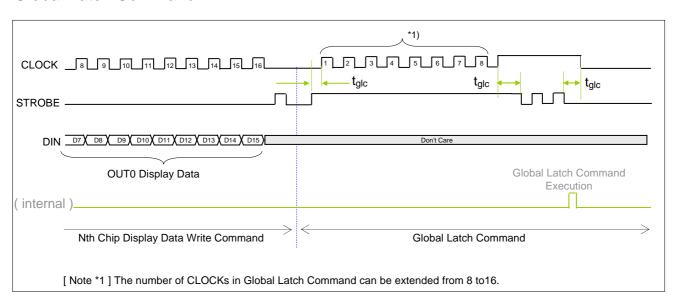
13



Display Data Write Command (0084h)

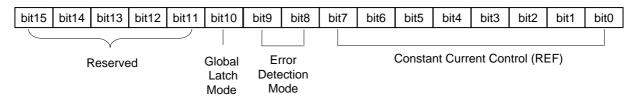


Global Latch Command





CONFIGURTION REGISTER (CR[15:0])



Constant Current Control (CR[7:0] Default 00h)

bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	Current Value
0	0	0	0	0	0	0	0	IOUT/256
0	0	0	0	0	0	0	1	IOUT*2/256
-	-	1	-	-	ı	1	-	-
0	1	1	1	1	1	1	1	IOUT*128/256
-	-	-	-	-	-	-	=	-
1	1	1	1	1	1	1	0	IOUT*255/256
1	1	1	1	1	1	1	1	IOUT

The IOUT is a constant current of OUTn port which is determined by REXT resistor.

Error Detection Mode (CR[9:8] Default 00b)

bit9	bit8	Error Mode		
0	0	Check Disable		
0	1	Open Check		
1	0	Short Check		
1	1	Check Disable		

Global Latch Mode (CR[10] Default 0b)

bit10	Global Latch Mode		
0	One Shot		
1	Automatic Synchronization		

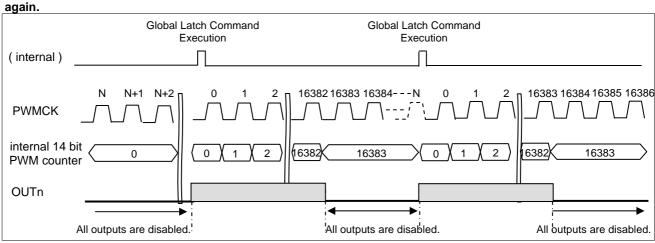


SYNCHRONIZATION FOR PWM COUNTING

The LD1071's Global Latch Command supports two kinds of synchronization mode for PWM counting. The default mode is One Shot Mode(Configuration Register bit10=0) and the other mode is Automatic Synchronization Mode(Configuration Register bit10=1).

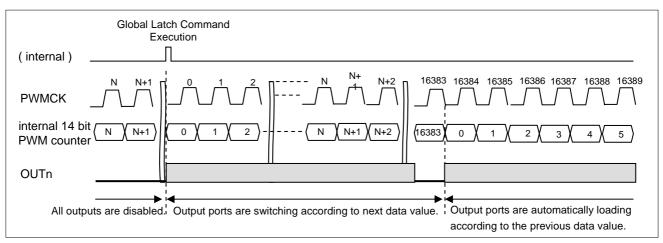
One Shot Mode (Default)

When Global Latch Command is executed in this mode, the LD1071 will update the next image data into output ports immediately, no matter what the counting status of previous image data is. The 14 bit internal PWM Counter is initialized with 0000h and the internal PWM counter starts counting with PWMCK clock. When the internal PWM counter value is reached to FFFFh, the internal PWM counter stops the counting even next PWMCK clock is inputting continuously. As a result, all the outputs will be stopped after finishing one internal PWM display cycle (16384 PWMCK clocks). Only the next Global Latch Command can initialize the counting



Automatic Synchronization Mode

When Global Latch Command is executed in this mode(Global Latch Mode=1), the LD1071 will update the next image data into output ports immediately, no matter what the counting status of previous image data is. When the internal PWM counter value is reached to FFFFh, if there is no Global Latch Command, the LD1071 automatically loads the previous image data into output ports at next 16384th PWMCK clock again. So in this mode, output ports will be automatically updated at every 16384 PWMCK clocks with previous data.



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WRITING THE DISPLAY DATA

With the 16 bit data, all output ports can be built with 16,384 gray scales. The 16-bit input shift register latches 16 times of gray scale data into each data buffer with Display Data Write Command sequentially. Finally Global Latch Command will load the 256 bit internal data buffers with LSB first into from output port 15(OUT15) to output port 0(OUT0). Even 16 bit display data for each port should be transferred, only 14 bits data are valid for gray scale image (bit[13:0]) and the high 2bits(bit[15:14]) are reserved. For the detail timing and sequence, refer to "Display Data Write Command" and "Global Latch Command" which is described on page 14, please.

PWM DISPLAY CYCLE

The LD1071 implements the 14 bit gray level of each output port using the 4 PWM sub cycles. Each PWM sub cycle is consisted of 12 bit PWMCK clocks. This enhancement provides a excellent energy distribution in lighting the LED and increases the visual refresh rate and reduces the flickers.

D[15:14] : Reserved

D[13:0] : Display Data(14 bit Gray Scale Data)

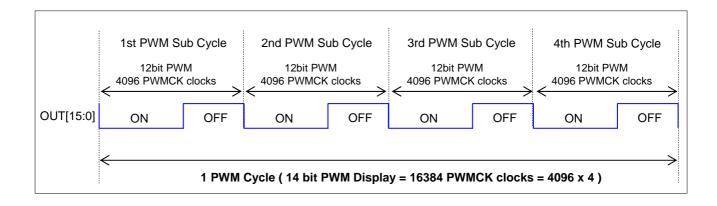
bit[13:2] : 12bit PWM Comparing Data

bit[1: 0] : PWM Insert data

1 1 : one pulse is inserted in 1st, 2nd and 3rd PWM Sub Cycle
1 0 : one pulse is inserted in 1st and 2nd PWM Sub Cycle

0 1 : one pulse is inserted in 1st PWM Sub Cycle

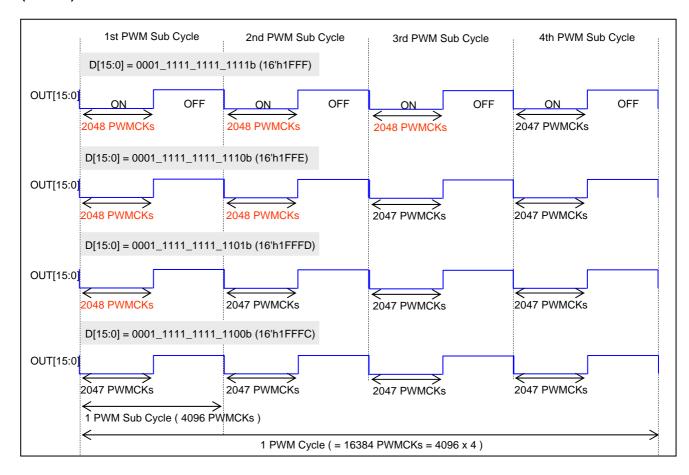
0 0 : Not inserted





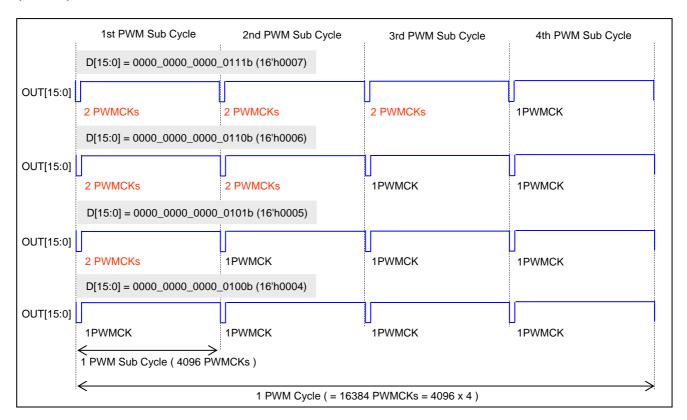
The following examples show the PWM timing diagram for different display data.

(Case 1)

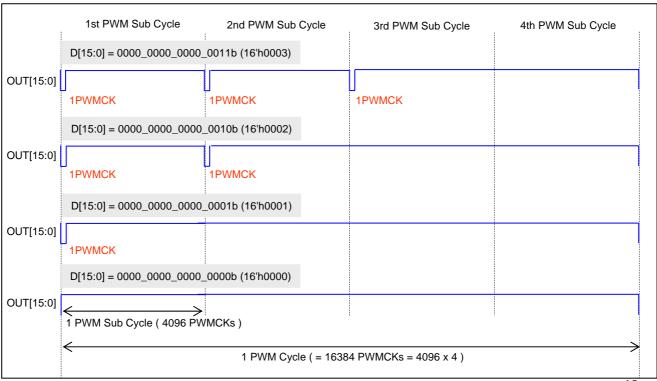




(Case 2)



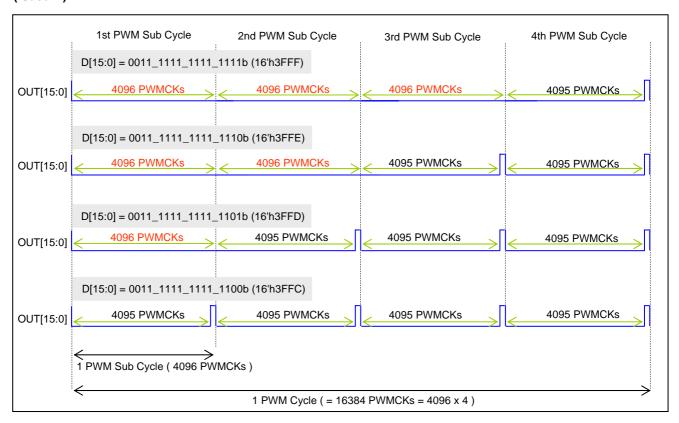
(Case 3)



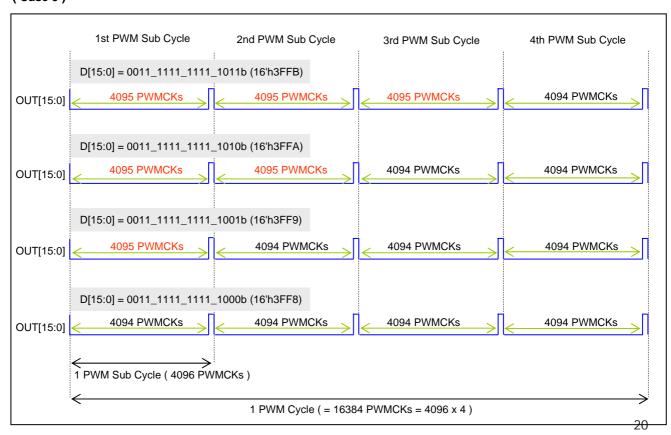
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(Case 4)



(Case 5)





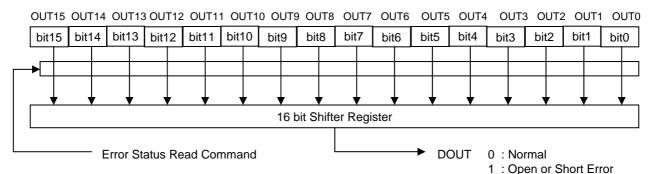
ERROR DETECTION

The LD1071 will be able to detect the error status of LED such as open/short error. This function can be entered by setting the bits of Error Detection Mode(CR[9:8]) as 01b(Open Detection) or 10b(Short Detection). The correct meaning of error is defined as follows;

- Open Error: Output port(OUTn) is not connected to LED.
- Short Error : Output port(OUTn) is shorted to GND.

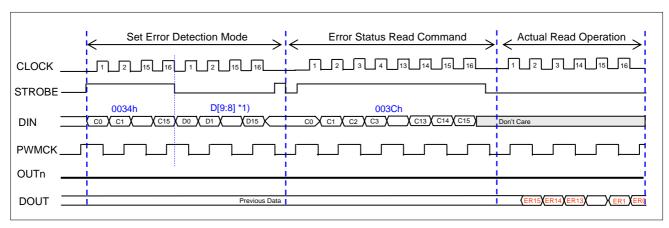
		Error Detection Code						
	Output Port status	Error Detection Voltage	Meaning					
Open Cheek	OFF	OUT Voltage > 0.8V	Normal					
Open Check	OFF	OUT Voltage < 0.8V	Open Error					
Short Check	OFF	OUT Voltage > 0.8V	Normal					
Snort Check	OFF	OUT Voltage < 0.8V	Short Error					

Error Status Register (ER[15:0])



Timing Diagram of Error Status Check

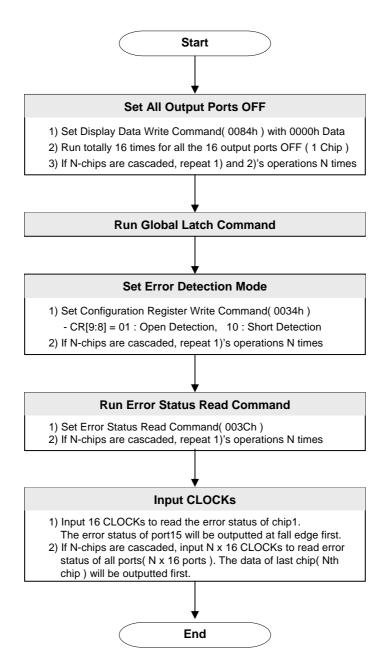
The next timing diagram shows the sequence of error status read operation. The actual error status is read with MSB first after execution of Error Status Read Command. First of all, in order to read the error status, all the output ports (OUT15~OUT0) should be off. So you need some pre-processing for error status read. The flow chart will be provided on next page.



Note *1) In order to keep the Constant Current Value(CR[7:0]) and Global Latch Mode(CR[10]) correctly, maybe you need to read the Configuration Register through the Configuration Register Read Command(0038h) prior to set Error Detection Mode.

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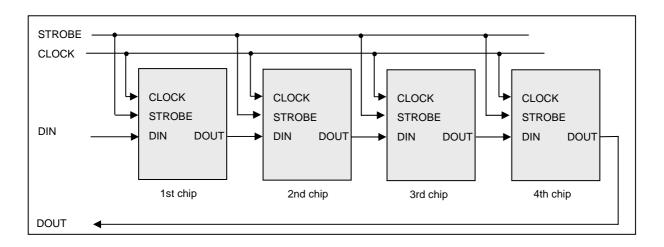




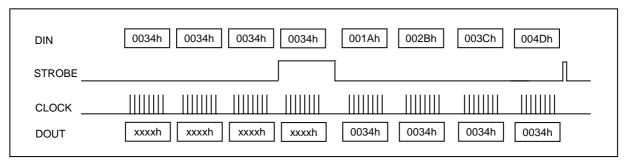
Flow Chart of Error Status Check



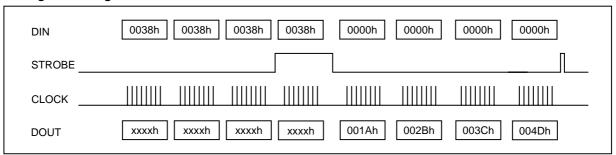
COMMAND SETTING GUIDE FOR MULTI-CHIP CASCADE CONFIGURATION



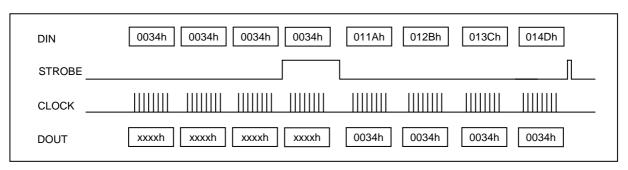
Configuration Register Write(Current Control)



Configuration Register Read

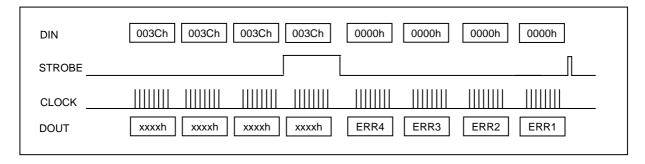


Configuration Register Write (Error Detection Enable)

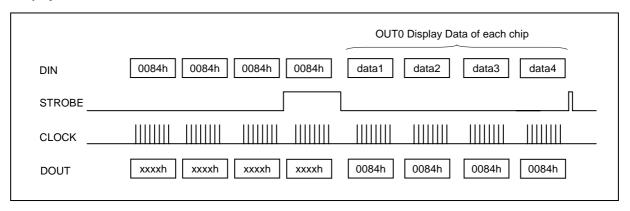




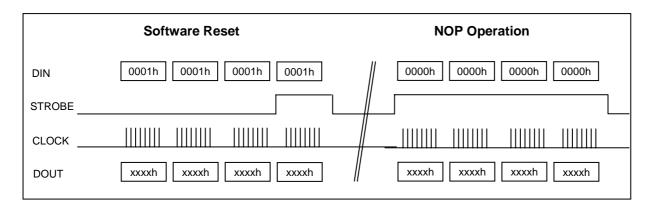
Error Status Read



Display Data Write

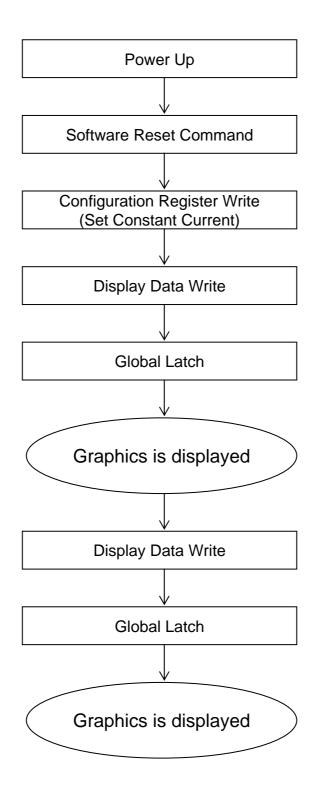


Software Reset & NOP Operation





RECOMMENDATION OF GLOBAL SEQUENCE



The first command should be issued after 0.1ms from Power-Up.



SETTING OUTPUT CURRENT

The output current is determined by an external resistor. The relationship between I_{OUT} and R_{EXT} is as follows;

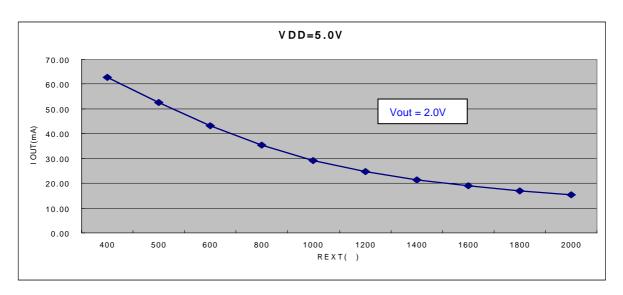
When VDD = 5V
$$I_{OUT}[A] = \{1.06/(120 + R_{EXT})\} * S * 61.4$$
 where $S = (REF + 1)/512$

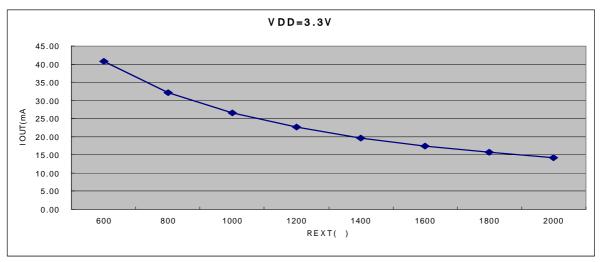
When VDD = 3.3V $I_{OUT}[A] = \{1.06/(150 + R_{EXT})\} * S * 57.6$ where S = (REF + 1)/512

- R_{EXT} : External Resistor[]

- REF : Constant Current Control (0 ~ 255, CR[7:0] of Configuration Register)

Because the default REF value(CR[7:0]) of Configuration Register(0034h) for current control is 00h, if you want to set the output current through changing the REXT value with following graph, do not forget to write the CR[7:0] of Configuration Register with 'FFh', please.





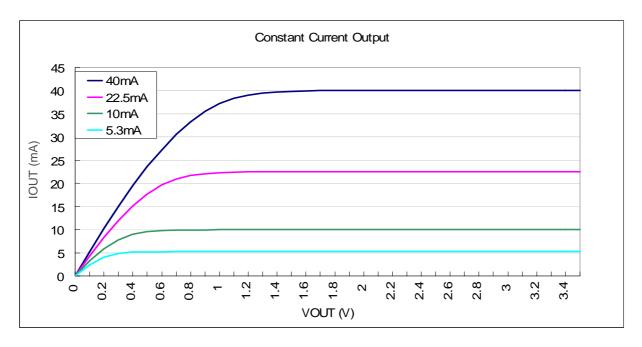
[Note] When VDD is 3.3V, in order to guarantee the accurate output current, do not set the lout to over 40mA, please.

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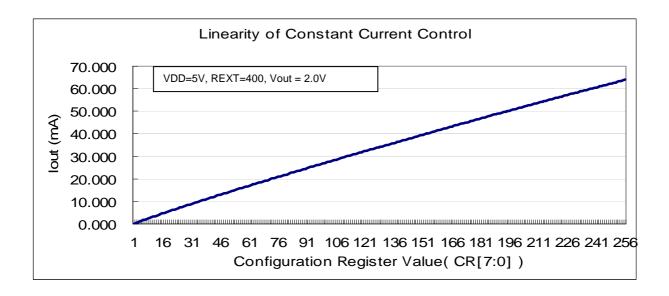
CONSTANT OUTPUT CURRENT

The LD1071 provides a constant current output characteristics for LED display application. The pin to pin deviation is max +/- 3% and chip to chip deviation is max +/- 6%.



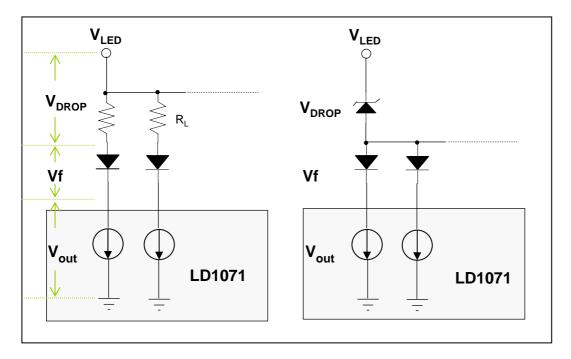
CONSTANT CURRENT CONTROL

The LD1071 provides a excellent lout linearity by setting the Configuration Register for global brightness control. The following graph shows the linearity example under the condition at VDD=5V, REXT=400 ohms and Vout = 2.0V.





LED SUPPLY VOLTAGE(VLED)



It is very important to select the proper value of Load Resistor(RL). Because the optimal VOUT value guarantees the constant output current and long life time of LED driver IC without over power consumption.

For example, let's calculate the Load Resistor value at VLED=5V, lout=20mA, LED Forward Voltage(Vf)=3V.

- 1) The full current of LD1018 = 20mA x 16 (channels) = 320mA
- 2) The power consumption is 320mA x VOUT voltage.
 - when VOUT = 1V, the power consumption is 320mW.
 - when VOUT= 2V, the power consumption is 640mW.

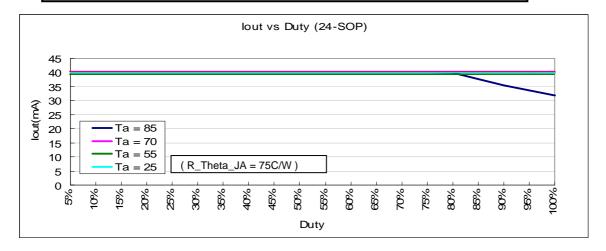
Therefore, the Load Resistor (RL) = (VLED - VOUT - Vf) / lout= (5V - VOUT - 3V) / 20mA= 40 (When VOUT = 1.2V)

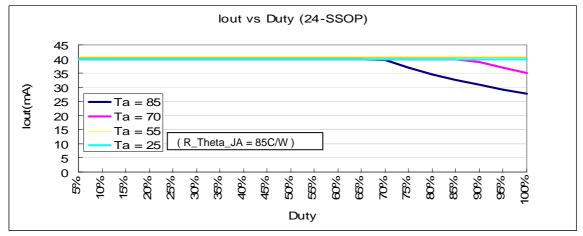


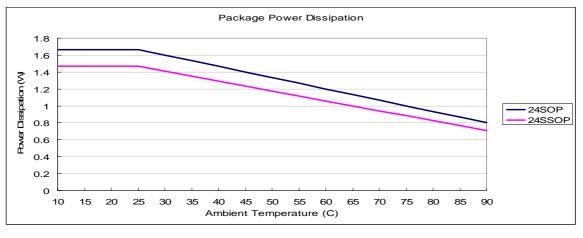
PACKAGE POWER DISSIPATION(PD)

The LD1071 provides many package options such as 24-SOP package and 24-SSOP package. The maximum allowable package power dissipation is determined as PD(max) = $(Tj - Ta) / R_Theta_JA$. When 16 output ports are turned on simultaneously, the actual power package dissipation is PD(act) = $(IDD \times VDD) + (IOUT \times Duty \times VOUT \times 16)$. Therefore, to keep that PD(act) is less equal than PD(max). The maximum allowable output current as a function of duty cycle is:

 $IOUT = \{[(Tj - Ta) / R_Theta_JA] - (IDD x VDD)\} / VOUT / Duty / 16 where Tj = 150C$



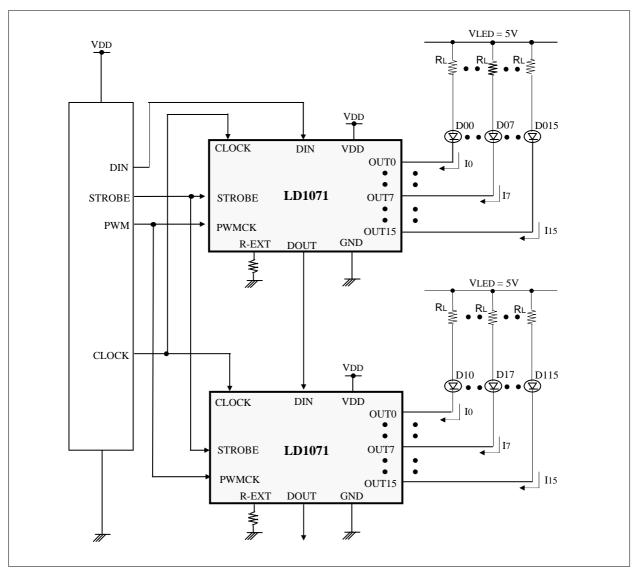




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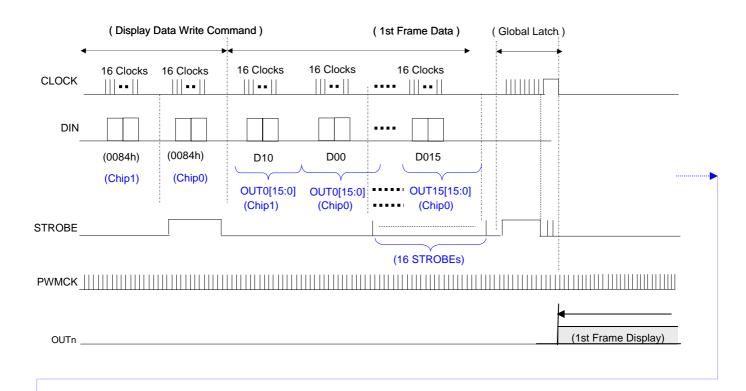
APPLICATION CIRCUIT 1 (16x2 Static Type)

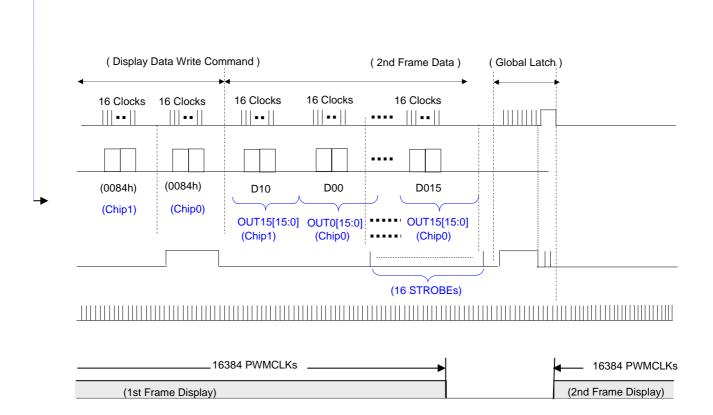


Data & Control Signal Connection for 16x2 Static Type Application



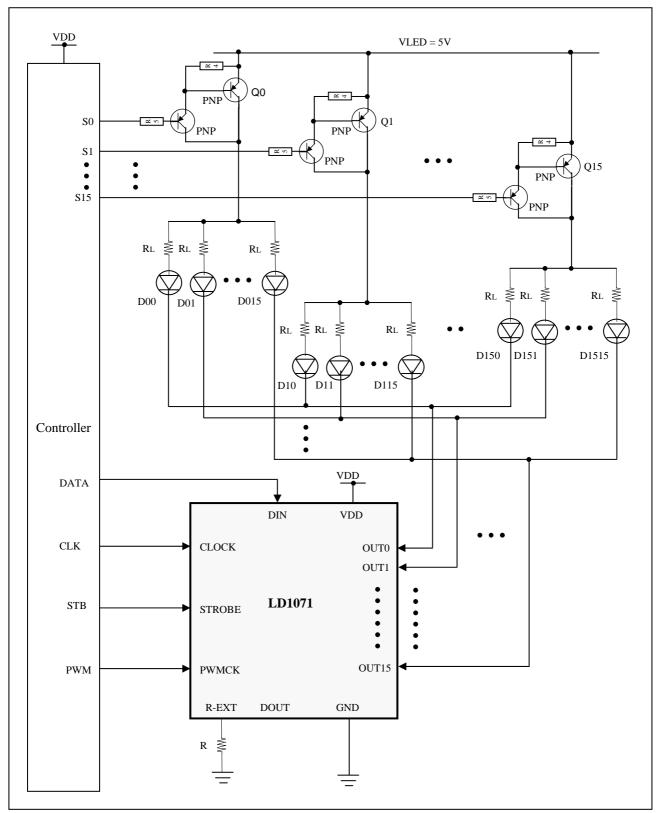
TIMING DIAGRAM FOR APPLICATION CIRCUIT 1 (Default One Shot Mode)







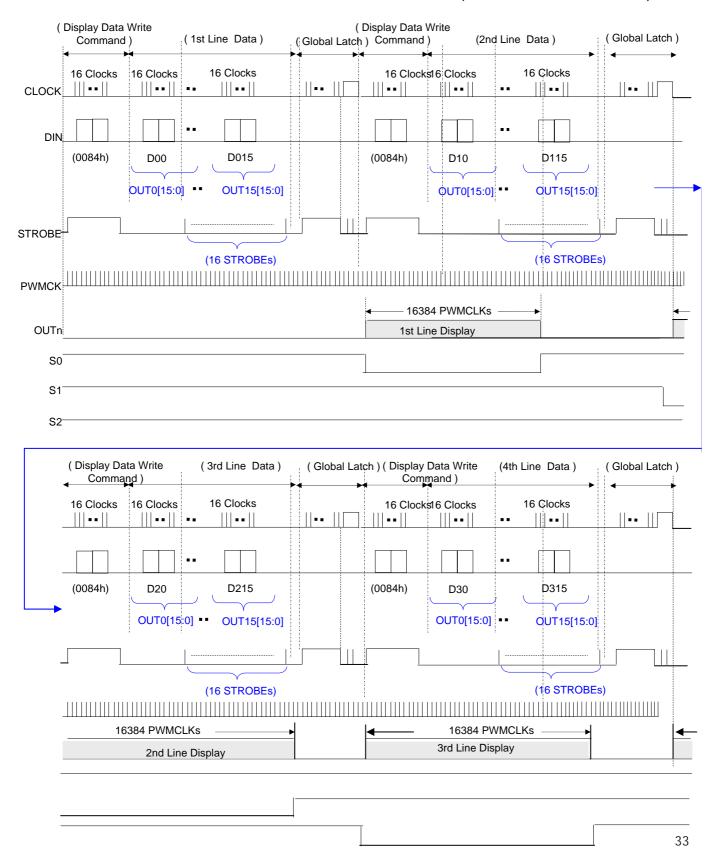
APPLICATION CIRCUIT 2 (16x16 Dynamic Type)



Data & Control Signal Connection for 16x16 Dynamic Type Application



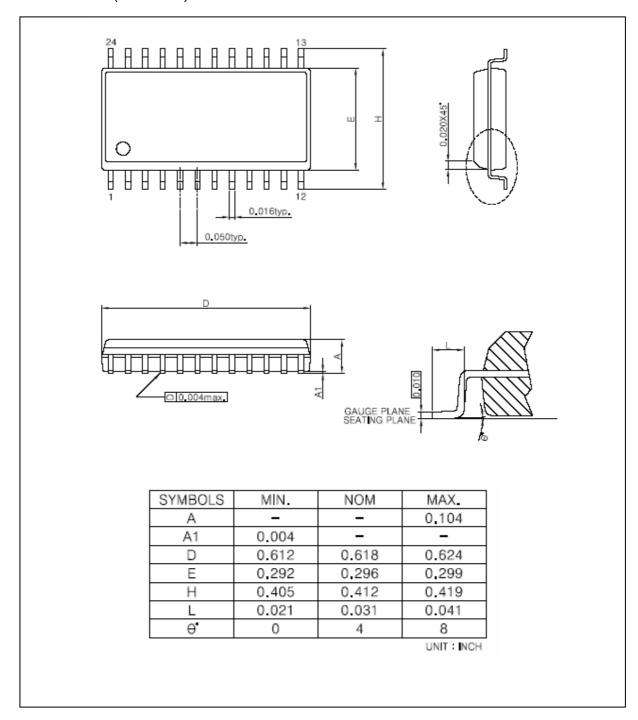
TIMING DIAGRAM FOR APPLICATION CIRCUIT 2 (Default One Shot Mode)





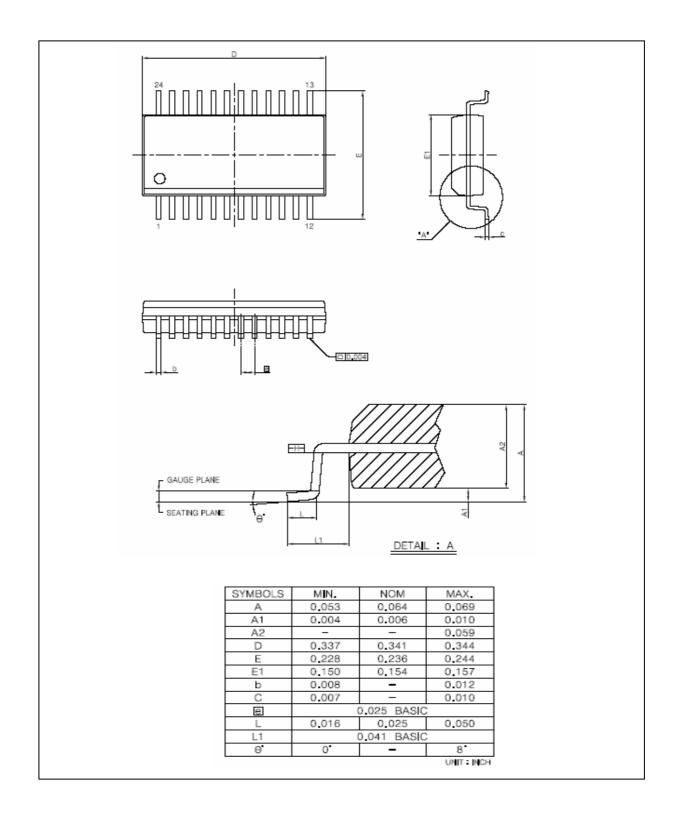
PACKAGE INFORMATION

LD1071-SP (SOP 24)





LD1071-SS (SSOP 24 - 150)









The products listed herein are designed for ordinary electronic applications, such as electrical applications, audio-visual equipment, communications devices and so on. Hence, it is advisable that the devices should not be used in medical instrument, surgical implants, aerospace machinery, nuclear power control systems, disaster/crime-prevention equipment and the like. Misusing those products may directly or indirectly endanger human life, or cause injury and property loss.

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